

## **MOSFET**

### OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V

#### **Features**

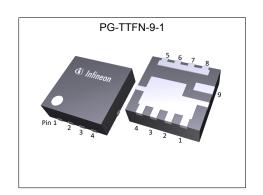
- Optimized for high performance SMPS, e.g. sync. rec.
- 100% avalanche tested
- Superior thermal resistance
- N-channel
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

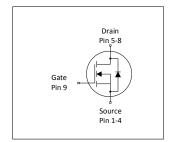
### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

| Parameter               | Value | Unit |
|-------------------------|-------|------|
| V <sub>DS</sub>         | 100   | V    |
| R <sub>DS(on),max</sub> | 6.5   | mΩ   |
| I <sub>D</sub>          | 85    | A    |
| Qoss                    | 40    | nC   |
| Q <sub>G</sub> (0V10V)  | 34    | nC   |











| Type / Ordering Code | Package     | Marking | Related Links |
|----------------------|-------------|---------|---------------|
| IQE065N10NM5CG       | PG-TTFN-9-1 | 06510C5 | -             |

# OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V



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## OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V IQE065N10NM5CG



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

| Davamatar                                    | Cymahal                           | Values      |      |                |      | N  |
|--|-----------------------------------|-------------|------|----------------|------|--|
| Parameter                                    | Symbol                            | Min.        | Тур. | Max.           | Unit | Note / Test Condition  |
| Continuous drain current <sup>1)</sup>       | I <sub>D</sub>                    | -<br>-<br>- | -    | 85<br>60<br>14 | А    | $V_{GS}$ =10 V, $T_{C}$ =25 °C<br>$V_{GS}$ =10 V, $T_{C}$ =100 °C<br>$V_{GS}$ =10V, $T_{A}$ =25°C, $R_{thJA}$ =60°C/W <sup>2</sup> ) |
| Pulsed drain current <sup>3)</sup>           | I <sub>D,pulse</sub>              | -           | -    | 341            | Α    | <i>T</i> <sub>A</sub> =25 °C   |
| Avalanche energy, single pulse <sup>4)</sup> | <b>E</b> AS                       | -           | -    | 147            | mJ   | $I_D$ =20 A, $R_{GS}$ =25 $\Omega$   |
| Gate source voltage                          | V <sub>GS</sub>                   | -20         | -    | 20             | V    | -  |
| Power dissipation                            | P <sub>tot</sub>                  | -           | -    | 100<br>2.5     | W    | T <sub>C</sub> =25 °C<br>T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 °C/W <sup>3)</sup>   |
| Operating and storage temperature            | T <sub>j</sub> , T <sub>stg</sub> | -55         | -    | 175            | °C   | IEC climatic category; DIN IEC 68-1 55/175/56  |

#### 2 Thermal characteristics

#### Table 3 Thermal characteristics

| Doromotor                                   | Cumbal            | Values |      |      | l lmi4 | Note / Test Condition |
|---|-------------------|--------|------|------|--------|-----------------------|
| Parameter                                   | Symbol            | Min.   | Тур. | Max. | Unit   | Note / Test Condition |
| Thermal resistance, junction - case, bottom | R <sub>thJC</sub> | -      | 0.8  | 1.5  | °C/W   | -                     |
| Device on PCB,<br>6 cm² cooling area²)      | R <sub>thJA</sub> | -      | -    | 60   | °C/W   | -                     |

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

## OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V IQE065N10NM5CG



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

| Davamatar                        | 0                    |      | Value      | s          |      |   |
|----------------------------------|----------------------|------|------------|------------|------|---|
| Parameter                        | Symbol               | Min. | Тур.       | Max.       | Unit | Note / Test Condition   |
| Drain-source breakdown voltage   | V <sub>(BR)DSS</sub> | 100  | -          | -          | V    | V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA  |
| Gate threshold voltage           | V <sub>GS(th)</sub>  | 2.2  | 3.0        | 3.8        | V    | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =48 μA  |
| Zero gate voltage drain current  | I <sub>DSS</sub>     | -    | 0.1<br>10  | 1.0<br>100 | μΑ   | V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C<br>V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C |
| Gate-source leakage current      | $I_{\mathrm{GSS}}$   | -    | 10         | 100        | nA   | V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V   |
| Drain-source on-state resistance | R <sub>DS(on)</sub>  | -    | 5.7<br>7.2 | 6.5<br>11  | mΩ   | V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A<br>V <sub>GS</sub> =6 V, I <sub>D</sub> =10 A   |
| Gate resistance                  | R <sub>G</sub>       | -    | 0.6        | -          | Ω    | -   |
| Transconductance                 | <b>g</b> fs          | -    | 55         | -          | S    | $ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 20 \text{ A}$  |

Table 5 **Dynamic characteristics** 

| Devementar                                 | Cumbal           | Values |      |      | 11:4 | Nata / Tank Canadiki an  |
|--|------------------|--------|------|------|------|--|
| Parameter                                  | Symbol           | Min.   | Тур. | Max. | Unit | Note / Test Condition  |
| Input capacitance <sup>1)</sup>            | Ciss             | -      | 2300 | 3000 | pF   | V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz                                   |
| Output capacitance <sup>1)</sup>           | Coss             | -      | 340  | 440  | pF   | V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz                                   |
| Reverse transfer capacitance <sup>1)</sup> | C <sub>rss</sub> | -      | 18   | 32   | pF   | V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz                                   |
| Turn-on delay time                         | $t_{\sf d(on)}$  | -      | 8.9  | -    | ns   | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$ |
| Rise time                                  | t <sub>r</sub>   | -      | 3.8  | -    | ns   | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$ |
| Turn-off delay time                        | $t_{ m d(off)}$  | -      | 21.1 | -    | ns   | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$ |
| Fall time                                  | t <sub>f</sub>   | -      | 7.5  | -    | ns   | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$ |

Table 6 Gate charge characteristics<sup>2)</sup>

| Danamatan                          | Ol                   | Values |      |      |      |  |
|------------------------------------|----------------------|--------|------|------|------|--|
| Parameter                          | Symbol               | Min.   | Тур. | Max. | Unit | Note / Test Condition  |
| Gate to source charge              | Q <sub>gs</sub>      | -      | 10.1 | -    | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge at threshold           | $Q_{g(th)}$          | -      | 6.8  | -    | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Gate to drain charge <sup>1)</sup> | Q <sub>gd</sub>      | -      | 7.4  | 11   | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Switching charge                   | Q <sub>sw</sub>      | -      | 10.7 | -    | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total <sup>1)</sup>    | Qg                   | -      | 34   | 42   | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Gate plateau voltage               | V <sub>plateau</sub> | -      | 4.4  | -    | V    | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total, sync. FET       | Q <sub>g(sync)</sub> | -      | 29   | -    | nC   | V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V             |
| Output charge <sup>1)</sup>        | Q <sub>oss</sub>     | -      | 40   | 54   | nC   | V <sub>DS</sub> =50 V, V <sub>GS</sub> =0 V                    |

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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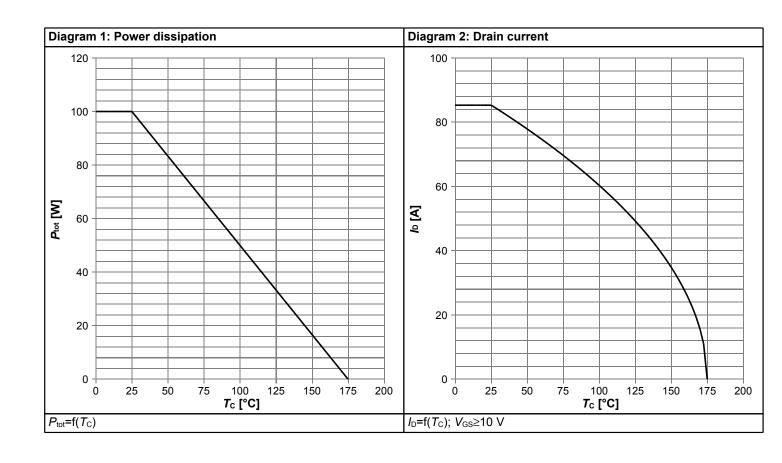


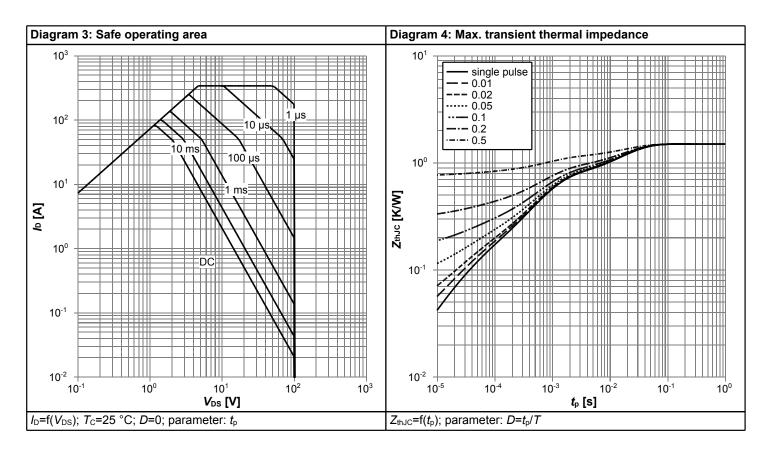
### Table 7 Reverse diode

| Davamatav                             | Cymphal                | Values |      |      | 11   | Nata / Tant Can dition  |  |
|---------------------------------------|------------------------|--------|------|------|------|---|--|
| Parameter                             | Symbol                 | Min.   | Тур. | Max. | Unit | Note / Test Condition   |  |
| Diode continuous forward current      | Is                     | -      | -    | 74   | Α    | <i>T</i> <sub>C</sub> =25 °C  |  |
| Diode pulse current                   | I <sub>S,pulse</sub>   | -      | -    | 341  | Α    | <i>T</i> <sub>C</sub> =25 °C  |  |
| Diode forward voltage                 | V <sub>SD</sub>        | -      | 0.83 | 1.1  | V    | V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C                         |  |
| Reverse recovery time <sup>1)</sup>   | <i>t</i> <sub>rr</sub> | -      | 36   | 72   | ns   | V <sub>R</sub> =50 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs |  |
| Reverse recovery charge <sup>1)</sup> | Qrr                    | -      | 40   | 80   | nC   | V <sub>R</sub> =50 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs |  |

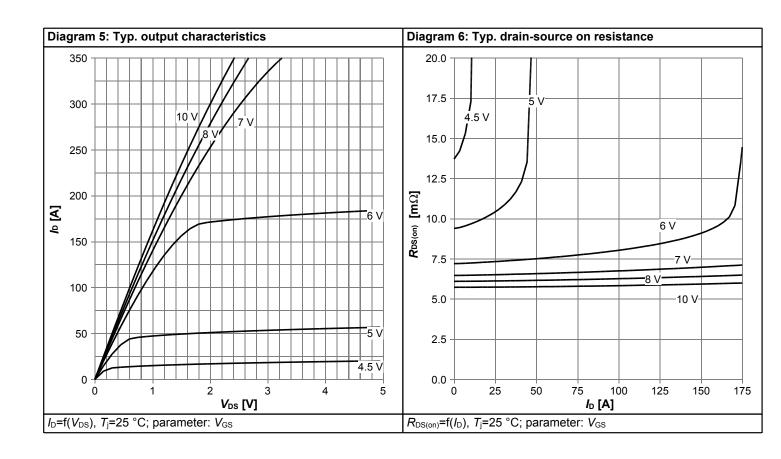


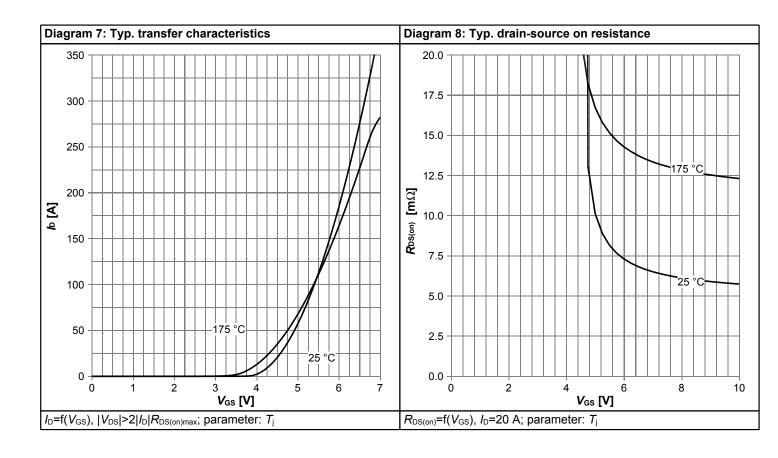
## 4 Electrical characteristics diagrams



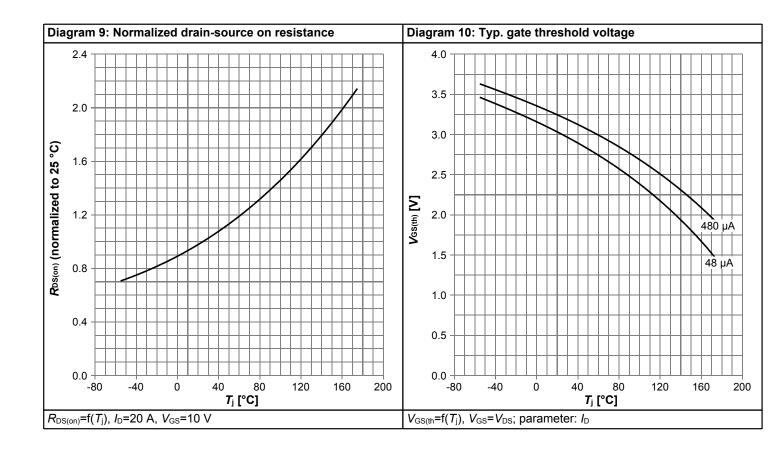


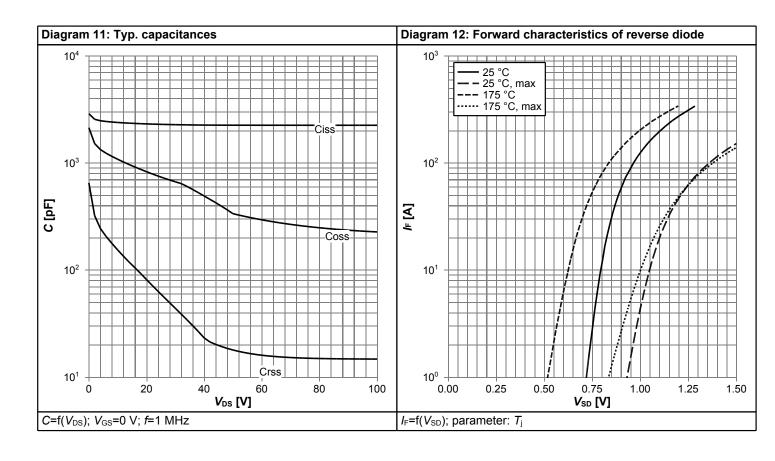




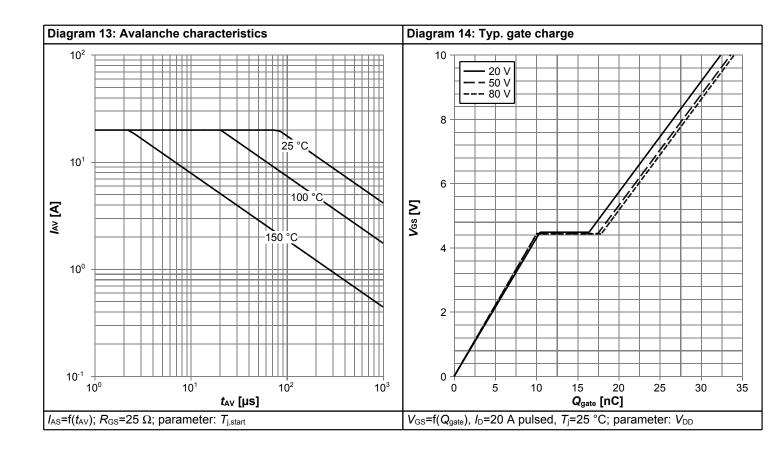


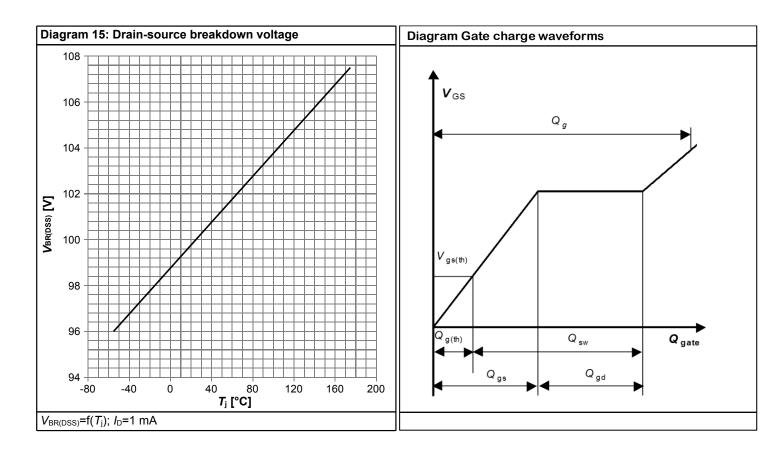






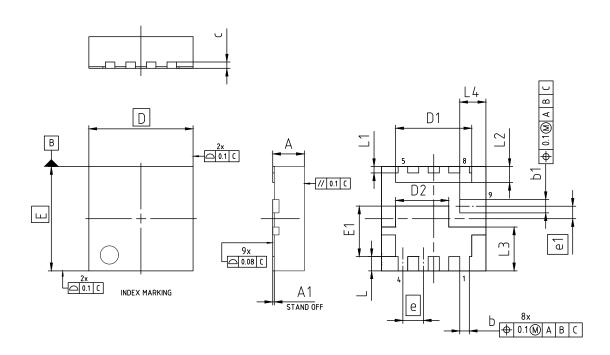








# 5 Package Outlines



| DIMENSION | MILLIM | IETERS |  |  |  |  |
|-----------|--------|--------|--|--|--|--|
| DIMENSION | MIN.   | MAX.   |  |  |  |  |
| Α         | -      | 1.10   |  |  |  |  |
| A1        | -      | 0.05   |  |  |  |  |
| b         | 0.20   | 0.40   |  |  |  |  |
| b1        | 0.32   | 0.52   |  |  |  |  |
| С         | 0.     | 20     |  |  |  |  |
| D         | 3.30   |        |  |  |  |  |
| D1        | 2.31   | 2.51   |  |  |  |  |
| D2        | 1.58   | 1.78   |  |  |  |  |
| E         | 3.30   |        |  |  |  |  |
| E1        | 1.50   | 1.70   |  |  |  |  |
| е         | 0.65   |        |  |  |  |  |
| e1        | 0.395  |        |  |  |  |  |
| L         | 0.35   | 0.55   |  |  |  |  |
| L1        | 0.10   | 0.30   |  |  |  |  |
| L2        | 0.40   | 0.60   |  |  |  |  |
| L3        | 1.285  | 1.485  |  |  |  |  |
| L4        | 0.73   | 0.93   |  |  |  |  |

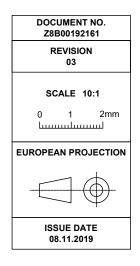


Figure 1 Outline PG-TTFN-9-1, dimensions in mm



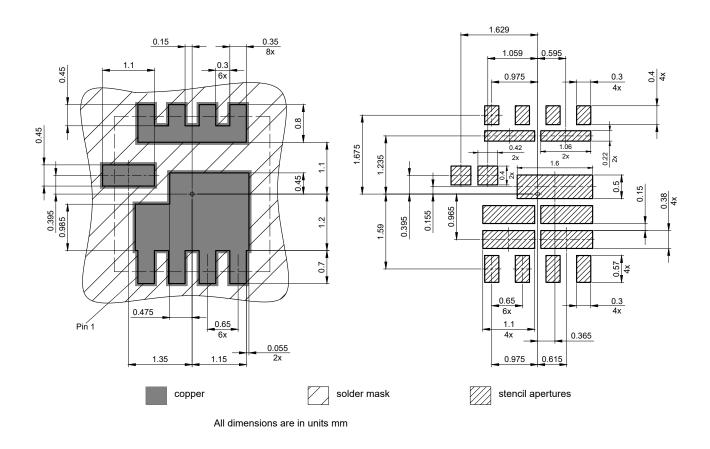


Figure 2 Outline Boardpad (PG-TTFN-9-1), dimensions in mm

# OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V IQE065N10NM5CG



### **Revision History**

IQE065N10NM5CG

Revision: 2021-12-01, Rev. 2.1

Previous Revision

| Revision | on Date Subjects (major changes since last revision) |                                      |  |  |  |  |
|----------|--|--------------------------------------|--|--|--|--|
| 2.0      | 2021-04-26   | Release of final version             |  |  |  |  |
| 2.1      | 2021-12-01   | Update "Marking" and Gate resistance |  |  |  |  |

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